Renesas Electronics America Inc - R5F21346XJFP#W4 Datasheet

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	R8C
Core Size	16-Bit
Speed	20MHz
Connectivity	CANbus, I²C, LINbus, SIO, SSU, UART/USART
Peripherals	POR, PWM, Voltage Detect, WDT
Number of I/O	43
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2.5K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 12x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f21346xjfp-w4

Table 1.4 Specifications for R8C/34X Group (2)

Item	Function	Specification
Serial Interface	UART0	1 channel Clock synchronous serial I/O, UART
	UART2	1 channel Clock synchronous serial I/O, UART, I^2C mode (I^2C-bus), IE mode (IEBus), multiprocessor communication function
Synchronous Serial Communication Unit (SSU)		1 channel
LIN Module		Hardware LIN: 1 (timer RA, UART0)
CAN Module		1 channel, 16 Mailboxes (conforms to the ISO 11898-1)
A/D Converter		10-bit resolution × 12 channels, includes sample and hold function, with sweep mode
Flash Memory		• Programming and erasure voltage: VCC = 2.7 to 5.5 V • Programming and erasure endurance: 100 times (program ROM) • Program security: ROM code protect, ID code check • Debug functions: On-chip debug, on-board flash rewrite function
Operating Frequency/Supply Voltage		f(XIN) = 20 MHz (VCC = 2.7 to 5.5 V)
Current Consumption		Typ. 7 mA (VCC = 5.0 V, f(XIN) = 20 MHz)
Operating Ambient Temperature		-40 to 85°C (J version) -40 to 125°C (K version) (1)
Package		48-pin LQFP Package code: PLQP0048KB-A (previous code: 48P6Q-A)

Note:
1. Specify the K version if K version functions are to be used.

Table 1.7 Specifications for R8C/34Z Group (1)

Item	Function	Specification
CPU	Central processing unit	R8C CPU core • Number of fundamental instructions: 89 • Minimum instruction execution time: 50 ns (f(XIN) = 20 MHz, VCC = 2.7 to 5.5 V) • Multiplier: 16 bits × 16 bits → 32 bits • Multiply-accumulate instruction: 16 bits × 16 bits + 32 bits → 32 bits • Operating mode: Single-chip mode (address space: 1 Mbyte)
Memory	ROM, RAM, Data flash	Refer to **Table 1.12 Product List for R8C/34Z Group**.
Power Supply Voltage Detection	Voltage detection circuit	• Power-on reset • Voltage detection 3 (detection level of voltage detection 1 selectable)
I/O Ports	Programmable I/O ports	• Input-only: 1 pin • CMOS I/O ports: 43, selectable pull-up resistor
Clock	Clock generation circuits	3 circuits: XIN clock oscillation circuit (with on-chip feedback resistor), High-speed on-chip oscillator (with frequency adjustment function), Low-speed on-chip oscillator • Oscillation stop detection: XIN clock oscillation stop detection function • Frequency divider circuit: Dividing selectable 1, 2, 4, 8, and 16 • Low power consumption modes: Standard operating mode (high-speed clock, high-speed on-chip oscillator, low-speed on-chip oscillator), wait mode, stop mode
Interrupts		• Interrupt vectors: 69 • External: 9 sources ($\overline{\text{INT}}$ × 5, key input × 4) • Priority levels: 7 levels
Watchdog Timer		• 14 bits × 1 (with prescaler) • Reset start selectable • Low-speed on-chip oscillator for watchdog timer selectable
DTC (Data Transfer Controller)		• 1 channel • Activation sources: 31 • Transfer modes: 2 (normal mode, repeat mode)
Timer	Timer RA	8 bits (with 8-bit prescaler) × 1 Timer mode (period timer), pulse output mode (output level inverted every period), event counter mode, pulse width measurement mode, pulse period measurement mode
	Timer RB	8 bits (with 8-bit prescaler) × 1 Timer mode (period timer), programmable waveform generation mode (PWM output), programmable one-shot generation mode, programmable wait one-shot generation mode
	Timer RC	16 bits (with 4 capture/compare registers) × 1 Timer mode (input capture function, output compare function), PWM mode (output 3 pins), PWM2 mode (PWM output pin)
	Timer RD	16 bits (with 4 capture/compare registers) × 2 Timer mode (input capture function, output compare function), PWM mode (output 6 pins), reset synchronous PWM mode (output three-phase waveforms (6 pins), sawtooth wave modulation), complementary PWM mode (output three-phase waveforms (6 pins), triangular wave modulation), PWM3 mode (PWM output 2 pins with fixed period)
	Timer RE	8 bits × 1 Output compare mode

Table 1.11 Product List for R8C/34Y Group **Current of Jan 2013**

Part No.	ROM Capacity		RAM Capacity	Package Type	Remarks
	Program ROM	Data flash			
R5F21346YJFP	32 Kbytes	1 Kbyte × 4	2.5 Kbytes	PLQP0048KB-A	J version
R5F21347YJFP	48 Kbytes	1 Kbyte × 4	4 Kbytes	PLQP0048KB-A	
R5F21348YJFP	64 Kbytes	1 Kbyte × 4	6 Kbytes	PLQP0048KB-A	
R5F2134AYJFP	96 Kbytes	1 Kbyte × 4	8 Kbytes	PLQP0048KB-A	
R5F2134CYJFP	128 Kbytes	1 Kbyte × 4	10 Kbytes	PLQP0048KB-A	
R5F21346YKFP	32 Kbytes	1 Kbyte × 4	2.5 Kbytes	PLQP0048KB-A	K version
R5F21347YKFP	48 Kbytes	1 Kbyte × 4	4 Kbytes	PLQP0048KB-A	
R5F21348YKFP	64 Kbytes	1 Kbyte × 4	6 Kbytes	PLQP0048KB-A	
R5F2134AYKFP	96 Kbytes	1 Kbyte × 4	8 Kbytes	PLQP0048KB-A	
R5F2134CYKFP	128 Kbytes	1 Kbyte × 4	10 Kbytes	PLQP0048KB-A	

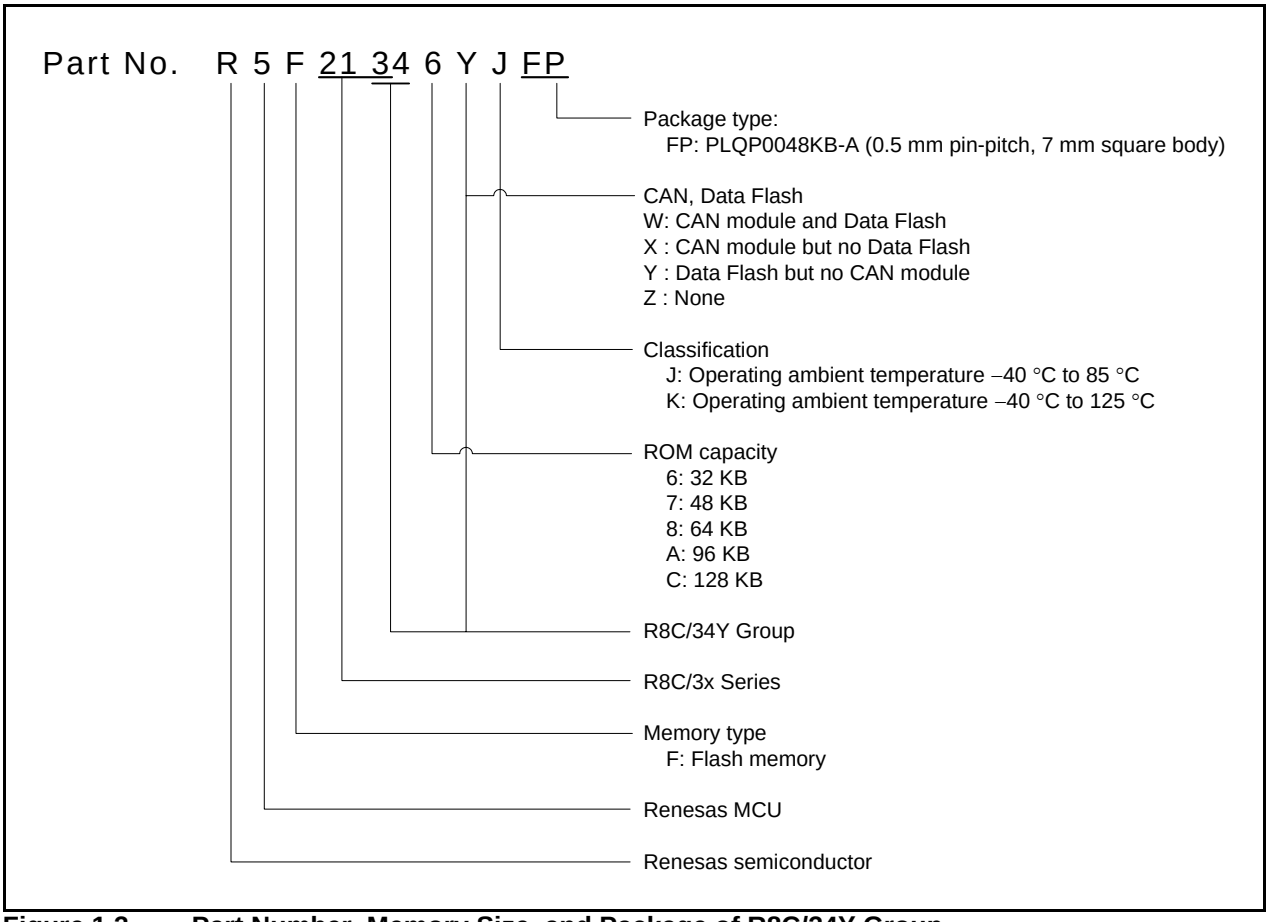


Figure 1.3 Part Number, Memory Size, and Package of R8C/34Y Group

Table 1.12 Product List for R8C/34Z Group **Current of Jan 2013**

Part No.	ROM Capacity Program ROM	RAM Capacity	Package Type	Remarks
R5F21346ZJFP	32 Kbytes	2.5 Kbytes	PLQP0048KB-A	J version
R5F21347ZJFP	48 Kbytes	4 Kbytes	PLQP0048KB-A	
R5F21348ZJFP	64 Kbytes	6 Kbytes	PLQP0048KB-A	
R5F2134AZJFP	96 Kbytes	8 Kbytes	PLQP0048KB-A	
R5F2134CZJFP	128 Kbytes	10 Kbytes	PLQP0048KB-A	
R5F21346ZKFP	32 Kbytes	2.5 Kbytes	PLQP0048KB-A	K version
R5F21347ZKFP	48 Kbytes	4 Kbytes	PLQP0048KB-A	
R5F21348ZKFP	64 Kbytes	6 Kbytes	PLQP0048KB-A	
R5F2134AZKFP	96 Kbytes	8 Kbytes	PLQP0048KB-A	
R5F2134CZKFP	128 Kbytes	10 Kbytes	PLQP0048KB-A	

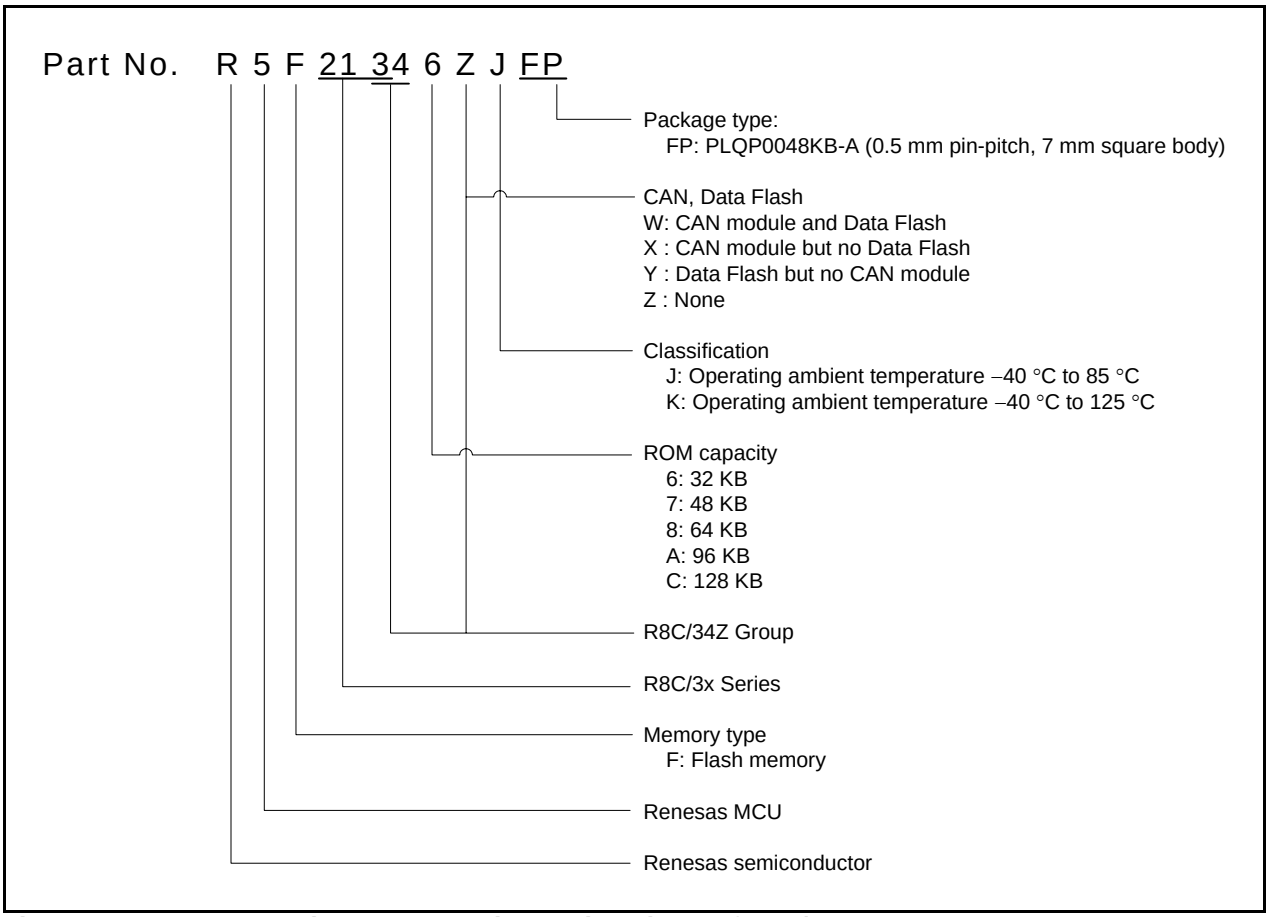


Figure 1.4 Part Number, Memory Size, and Package of R8C/34Z Group

Table 1.14 Pin Name Information by Pin Number (2)

Pin Number	Control Pin	Port	I/O Pin Functions for Peripheral Modules					
			Interrupt	Timer	Serial Interface	SSU	CAN Module (2)	A/D Converter Voltage Detection Circuit
27		P6_7	$\overline{\text{INT3}}$ (1)	TRCIOD	(RXD2)/(SCL2) (1)			
28		P1_2	$\overline{\text{KI2}}$	TRCIOB				AN10
29		P1_1	$\overline{\text{KI1}}$	TRCIOA/ TRCTRG				AN9
30		P1_0	$\overline{\text{KI0}}$					AN8
31		P3_1		(TRBO) (1)				
32		P3_0		(TRAO) (1)				
33		P6_5	$\overline{\text{INT4}}$		(CLK2) (1)			
34		P6_4						
35		P6_3						
36		P0_7						AN0
37		P0_6						AN1
38		P0_5						AN2
39		P0_4		TREO				AN3
40		P4_2						VREF
41		P6_0		(TREO) (1)				
42		P6_2					CRX0 (2)	
43		P6_1					CTX0 (2)	
44		P0_3						AN4
45		P0_2						AN5
46		P0_1						AN6
47		P0_0						AN7
48		P3_7		(TRAO) (1)	(TXD2)/(SDA2)/ (RXD2)/(SCL2) (1)	SSO		

Notes:
1. This can be assigned to the pin in parentheses by a program.
2. Only for the R8C/34W Group and R8C/34X Group.

1.5 Pin Functions

Tables 1.15 and 1.16 list Pin Functions.

Table 1.15 Pin Functions (1)

Item	Pin Name	I/O Type	Description
Power supply input	VCC, VSS	–	Apply 2.7 V to 5.5 V to the VCC pin. Apply 0 V to the VSS pin.
Analog power supply input	AVCC, AVSS	–	Power supply for the A/D converter. Connect a capacitor between AVCC and AVSS.
Reset input	$\overline{\text{RESET}}$	I	Input “L” on this pin resets the MCU.
MODE	MODE	I	Connect this pin to VCC via a resistor.
XIN clock input	XIN	I	These pins are provided for XIN clock generation circuit I/O. Connect a ceramic resonator or a crystal oscillator between the XIN and XOUT pins (1). To use an external clock, input it to the XOUT pin and leave the XIN pin open.
XIN clock output	XOUT	I/O	
$\overline{\text{INT}}$ interrupt input	$\overline{\text{INT0}}$ to $\overline{\text{INT4}}$	I	$\overline{\text{INT}}$ interrupt input pins.
Key input interrupt	$\overline{\text{KI0}}$ to $\overline{\text{KI3}}$	I	Key input interrupt input pins
Timer RA	TRAIO	I/O	Timer RA I/O pin
	TRAO	O	Timer RA output pin
Timer RB	TRBO	O	Timer RB output pin
Timer RC	TRCCLK	I	External clock input pin
	TRCTRG	I	External trigger input pin
	TRCIOA, TRCIOB, TRCIOC, TRCIOD	I/O	Timer RC I/O pins
Timer RD	TRDIOA0, TRDIOA1, TRDIOB0, TRDIOB1, TRDIOC0, TRDIOC1, TRDIOD0, TRDIOD1	I/O	Timer RD I/O pins
	TRDCLK	I	External clock input pin
Timer RE	TREO	O	Divided clock output pin
Serial interface	CLK0, CLK2	I/O	Transfer clock I/O pins
	RXD0, RXD2	I	Serial data input pins
	TXD0, TXD2	O	Serial data output pins
	$\overline{\text{CTS2}}$	I	Transmission control input pin
	$\overline{\text{RTS2}}$	O	Reception control output pin
	SCL2	I/O	I^2C mode clock I/O pin
	SDA2	I/O	I^2C mode data I/O pin
SSU	SSI	I/O	Data I/O pin
	$\overline{\text{SCS}}$	I/O	Chip-select signal I/O pin
	SSCK	I/O	Clock I/O pin
	SSO	I/O	Data I/O pin

I: Input O: Output I/O: Input and output

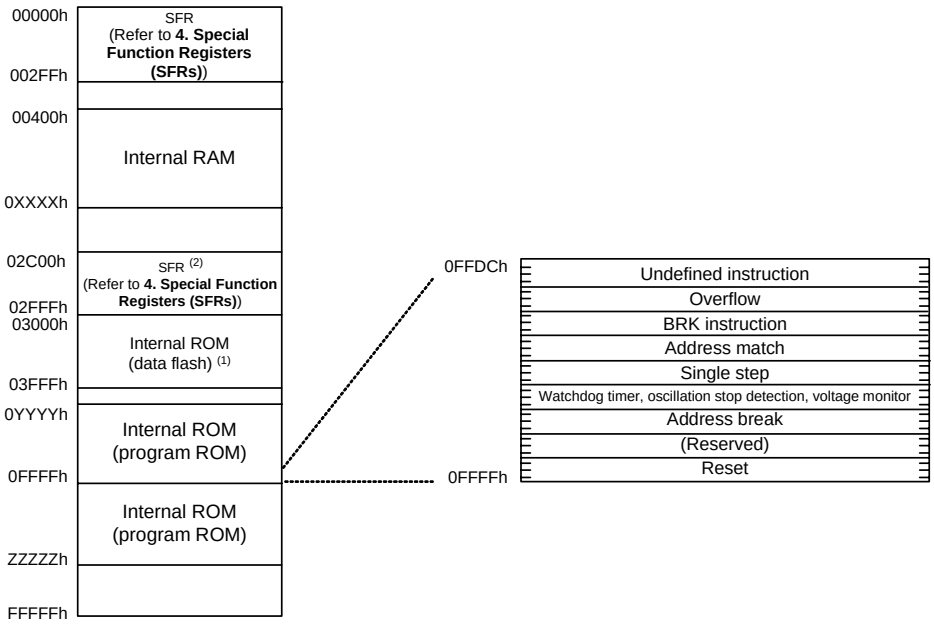
Note:

1. Refer to the oscillator manufacturer for oscillation characteristics.

3. Memory

3.1 R8C/34W Group

Figure 3.1 is a Memory Map of R8C/34W Group. The R8C/34W Group has a 1-Mbyte address space from addresses 00000h to FFFFFh. The internal ROM (program ROM) is allocated lower addresses, beginning with address 0FFFFh. For example, a 48-Kbyte internal ROM area is allocated addresses 04000h to 0FFFFh.
The fixed interrupt vector table is allocated addresses 0FFDCh to 0FFFFh. The starting address of each interrupt routine is stored here.
The internal ROM (data flash) is allocated addresses 03000h to 03FFFh.
The internal RAM is allocated higher addresses, beginning with address 00400h. For example, a 4-Kbyte internal RAM area is allocated addresses 00400h to 013FFh. The internal RAM is used not only for data storage but also as a stack area when a subroutine is called or when an interrupt request is acknowledged.
Special function registers (SFRs) are allocated addresses 00000h to 002FFh and 02C00h to 02FFFh (the SFR areas for the CAN, DTC, and other modules). Peripheral function control registers are allocated here. All unallocated spaces within the SFRs are reserved and cannot be accessed by users.



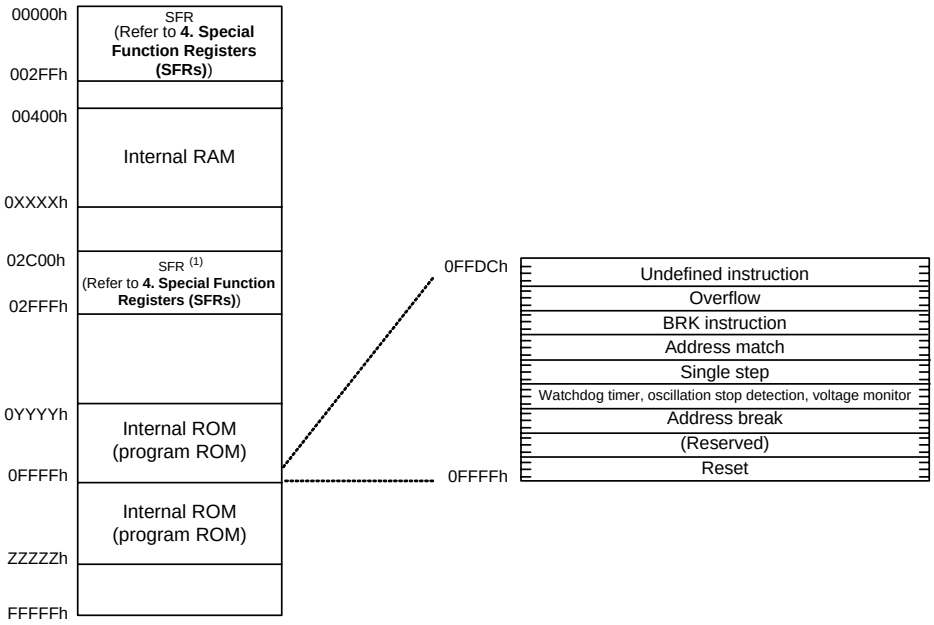
Notes:
1. The Data Flash memory indicates blocks A (1 Kbyte), B (1 Kbyte), C (1 Kbyte), and D (1 Kbyte).
2. The SFR areas for the CAN, DTC and other modules are allocated to addresses 02C00h to 02FFFh.
3. The blank areas are reserved and cannot be accessed by users.

Part Number	Internal ROM			Internal RAM	
	Size	Address 0YYYYh	Address ZZZZZh	Size	Address 0XXXXh
R5F21346WJFP, R5F21346WKFP	32 Kbytes	08000h	—	2.5 Kbytes	00DFFh
R5F21347WJFP, R5F21347WKFP	48 Kbytes	04000h	—	4 Kbytes	013FFh
R5F21348WJFP, R5F21348WKFP	64 Kbytes	04000h	13FFFh	6 Kbytes	01BFFh
R5F2134AWJFP, R5F2134AWKFP	96 Kbytes	04000h	1BFFFh	8 Kbytes	023FFh
R5F2134CWJFP, R5F2134CWKFP	128 Kbytes	04000h	23FFFh	10 Kbytes	02BFFh

Figure 3.1 Memory Map of R8C/34W Group

3.2 R8C/34X Group

Figure 3.2 is a Memory Map of R8C/34X Group. The R8C/34X Group has a 1-Mbyte address space from addresses 00000h to FFFFFh. The internal ROM (program ROM) is allocated lower addresses, beginning with address 0FFFFh. For example, a 48-Kbyte internal ROM area is allocated addresses 04000h to 0FFFFh.
The fixed interrupt vector table is allocated addresses 0FFDCh to 0FFFFh. The starting address of each interrupt routine is stored here.
The internal RAM is allocated higher addresses, beginning with address 00400h. For example, a 4-Kbyte internal RAM area is allocated addresses 00400h to 013FFh. The internal RAM is used not only for data storage but also as a stack area when a subroutine is called or when an interrupt request is acknowledged.
Special function registers (SFRs) are allocated addresses 00000h to 002FFh and 02C00h to 02FFFh (the SFR areas for the CAN, DTC, and other modules). Peripheral function control registers are allocated here. All unallocated spaces within the SFRs are reserved and cannot be accessed by users.



Notes:
1. The SFR areas for the CAN, DTC and other modules are allocated to addresses 02C00h to 02FFFh.
2. The blank areas are reserved and cannot be accessed by users.

Part Number	Internal ROM			Internal RAM	
	Size	Address 0YYYYh	Address ZZZZZh	Size	Address 0XXXXh
R5F21346XJFP, R5F21346XKFP	32 Kbytes	08000h	—	2.5 Kbytes	00DFFh
R5F21347XJFP, R5F21347XKFP	48 Kbytes	04000h	—	4 Kbytes	013FFh
R5F21348XJFP, R5F21348XKFP	64 Kbytes	04000h	13FFFh	6 Kbytes	01BFFh
R5F2134AXJFP, R5F2134AXKFP	96 Kbytes	04000h	1BFFFh	8 Kbytes	023FFh
R5F2134CXJFP, R5F2134CXKFP	128 Kbytes	04000h	23FFFh	10 Kbytes	02BFFh

Figure 3.2 Memory Map of R8C/34X Group

4. Special Function Registers (SFRs)

An SFR (special function register) is a control register for a peripheral function. Tables 4.1 to 4.17 list the special function registers. Table 4.18 lists the ID Code Areas and Option Function Select Area.

Table 4.1 SFR Information (1) (1)

Address	Register	Symbol	After reset
0000h			
0001h			
0002h			
0003h			
0004h	Processor Mode Register 0	PM0	00h
0005h	Processor Mode Register 1	PM1	00h
0006h	System Clock Control Register 0	CM0	00101000b
0007h	System Clock Control Register 1	CM1	00100000b
0008h	Module Standby Control Register	MSTCR	00h
0009h	System Clock Control Register 3	CM3	00h
000Ah	Protect Register	PRCR	00h
000Bh	Reset Source Determination Register	RSTFR	0XXXXXXXb (2)
000Ch	Oscillation Stop Detection Register	OCD	00000100b
000Dh	Watchdog Timer Reset Register	WDTR	XXh
000Eh	Watchdog Timer Start Register	WDTS	XXh
000Fh	Watchdog Timer Control Register	WDTC	00111111b
0010h			
0011h			
0012h			
0013h			
0014h			
0015h	High-Speed On-Chip Oscillator Control Register 7	FRA7	When shipping
0016h			
0017h			
0018h			
0019h			
001Ah			
001Bh			
001Ch	Count Source Protection Mode Register	CSPR	00h 10000000b (3)
001Dh			
001Eh			
001Fh			
0020h			
0021h			
0022h			
0023h	High-Speed On-Chip Oscillator Control Register 0	FRA0	00h
0024h	High-Speed On-Chip Oscillator Control Register 1	FRA1	When shipping
0025h	High-Speed On-Chip Oscillator Control Register 2	FRA2	00h
0026h	On-Chip Reference Voltage Control Register	OCVREFCR	00h
0027h			
0028h			
0029h	High-Speed On-Chip Oscillator Control Register 4	FRA4	When Shipping
002Ah	High-Speed On-Chip Oscillator Control Register 5	FRA5	When Shipping
002Bh	High-Speed On-Chip Oscillator Control Register 6	FRA6	When Shipping
002Ch			
002Dh			
002Eh			
002Fh	High-Speed On-Chip Oscillator Control Register 3	FRA3	When shipping
0030h	Voltage Monitor Circuit Control Register	CMPA	00h
0031h	Voltage Monitor Circuit Edge Select Register	VCAC	00h
0032h			
0033h	Voltage Detect Register 1	VCA1	00001000b
0034h	Voltage Detect Register 2	VCA2	00h (4) 00100000b (5)
0035h			
0036h	Voltage Detection 1 Level Select Register	VD1LS	00000111b
0037h			
0038h	Voltage Monitor 0 Circuit Control Register	VW0C	1100X010b (4) 1100X011b (5)
0039h	Voltage Monitor 1 Circuit Control Register	VW1C	10001010b

X: Undefined

Notes:
1. The blank areas are reserved and cannot be accessed by users.
2. The CWR bit in the RSTFR register is set to 0 after power-on and voltage monitor 0 reset. Hardware reset, Software reset, or watchdog timer reset does not affect this bit.
3. The CSPROINI bit in the OFS register is set to 0.
4. The LVDAS bit in the OFS register is set to 1.
5. The LVDAS bit in the OFS register is set to 0.

Table 4.2 SFR Information (2) (1)

Address	Register	Symbol	After reset
003Ah	Voltage Monitor 2 Circuit Control Register	VW2C	10000010b
003Bh			
003Ch			
003Dh			
003Eh			
003Fh			
0040h			
0041h	Flash Memory Ready Interrupt Control Register	FMRDYIC	XXXXX000b
0042h			
0043h			
0044h			
0045h			
0046h	INT4 Interrupt Control Register	INT4IC	XX00X000b
0047h	Timer RC Interrupt Control Register	TRCIC	XXXXX000b
0048h	Timer RD0 Interrupt Control Register	TRD0IC	XXXXX000b
0049h	Timer RD1 Interrupt Control Register	TRD1IC	XXXXX000b
004Ah	Timer RE Interrupt Control Register	TREIC	XXXXX000b
004Bh	UART2 Transmit Interrupt Control Register	S2TIC	XXXXX000b
004Ch	UART2 Receive Interrupt Control Register	S2RIC	XXXXX000b
004Dh	Key Input Interrupt Control Register	KUPIC	XXXXX000b
004Eh	A/D Conversion Interrupt Control Register	ADIC	XXXXX000b
004Fh	SSU Interrupt Control Register	SSUIC	XXXXX000b
0050h			
0051h	UART0 Transmit Interrupt Control Register	S0TIC	XXXXX000b
0052h	UART0 Receive Interrupt Control Register	S0RIC	XXXXX000b
0053h			
0054h			
0055h	INT2 Interrupt Control Register	INT2IC	XX00X000b
0056h	Timer RA Interrupt Control Register	TRAIC	XXXXX000b
0057h			
0058h	Timer RB Interrupt Control Register	TRBIC	XXXXX000b
0059h	INT1 Interrupt Control Register	INT1IC	XX00X000b
005Ah	INT3 Interrupt Control Register	INT3IC	XX00X000b
005Bh			
005Ch			
005Dh	INT0 Interrupt Control Register	INT0IC	XX00X000b
005Eh	UART2 Bus Collision Detection Interrupt Control Register	U2BCNIC	XXXXX000b
005Fh			
0060h			
0061h			
0062h			
0063h			
0064h			
0065h			
0066h			
0067h			
0068h			
0069h			
006Ah			
006Bh			
006Ch	CAN0 Reception Complete Interrupt Control Register	C0RIC	XXXXX000b
006Dh	CAN0 Transmission Complete Interrupt Control Register	C0TIC	XXXXX000b
006Eh	CAN0 Receive FIFO Interrupt Control Register	C0FRIC	XXXXX000b
006Fh	CAN0 Transmit FIFO Interrupt Control Register	C0FTIC	XXXXX000b
0070h	CAN0 Error Interrupt Control Register	C0EIC	XXXXX000b
0071h	CAN0 Wake-up Interrupt Control Register	C0WIC	XXXXX000b
0072h	Voltage Monitor 1 Interrupt Control Register	VCMP1IC	XXXXX000b
0073h	Voltage Monitor 2 Interrupt Control Register	VCMP2IC	XXXXX000b
0074h			
0075h			
0076h			
0077h			
0078h			
0079h			
007Ah			
007Bh			
007Ch			
007Dh			
007Eh			
007Fh			

X: Undefined

Note:

1. The blank areas are reserved and cannot be accessed by users.

Table 4.6 SFR Information (6) (1)

Address	Register	Symbol	After reset
0140h	Timer RD Control Register 0	TRDCR0	00h
0141h	Timer RD I/O Control Register A0	TRDIORA0	10001000b
0142h	Timer RD I/O Control Register C0	TRDIORC0	10001000b
0143h	Timer RD Status Register 0	TRDSR0	11100000b
0144h	Timer RD Interrupt Enable Register 0	TRDIER0	11100000b
0145h	Timer RD PWM Mode Output Level Control Register 0	TRDPOCR0	11111000b
0146h	Timer RD Counter 0	TRD0	00h
0147h			00h
0148h	Timer RD General Register A0	TRDGRA0	FFh
0149h			FFh
014Ah	Timer RD General Register B0	TRDGRB0	FFh
014Bh			FFh
014Ch	Timer RD General Register C0	TRDGRC0	FFh
014Dh			FFh
014Eh	Timer RD General Register D0	TRDGRD0	FFh
014Fh			FFh
0150h	Timer RD Control Register 1	TRDCR1	00h
0151h	Timer RD I/O Control Register A1	TRDIORA1	10001000b
0152h	Timer RD I/O Control Register C1	TRDIORC1	10001000b
0153h	Timer RD Status Register 1	TRDSR1	11000000b
0154h	Timer RD Interrupt Enable Register 1	TRDIER1	11100000b
0155h	Timer RD PWM Mode Output Level Control Register 1	TRDPOCR1	11111000b
0156h	Timer RD Counter 1	TRD1	00h
0157h			00h
0158h	Timer RD General Register A1	TRDGRA1	FFh
0159h			FFh
015Ah	Timer RD General Register B1	TRDGRB1	FFh
015Bh			FFh
015Ch	Timer RD General Register C1	TRDGRC1	FFh
015Dh			FFh
015Eh	Timer RD General Register D1	TRDGRD1	FFh
015Fh			FFh
0160h			
0161h			
0162h			
0163h			
0164h			
0165h			
0166h			
0167h			
0168h			
0169h			
016Ah			
016Bh			
016Ch			
016Dh			
016Eh			
016Fh			
0170h			
0171h			
0172h			
0173h			
0174h			
0175h			
0176h			
0177h			
0178h			
0179h			
017Ah			
017Bh			
017Ch			
017Dh			
017Eh			
017Fh			

X: Undefined
Note:
1. The blank areas are reserved and cannot be accessed by users.

Table 4.10 SFR Information (10) (1)

Address	Register	Symbol	After reset
2C70h	DTC Control Data 6	DTCD6	XXh
2C71h			XXh
2C72h			XXh
2C73h			XXh
2C74h			XXh
2C75h			XXh
2C76h			XXh
2C77h			XXh
2C78h	DTC Control Data 7	DTCD7	XXh
2C79h			XXh
2C7Ah			XXh
2C7Bh			XXh
2C7Ch			XXh
2C7Dh			XXh
2C7Eh			XXh
2C7Fh			XXh
2C80h	DTC Control Data 8	DTCD8	XXh
2C81h			XXh
2C82h			XXh
2C83h			XXh
2C84h			XXh
2C85h			XXh
2C86h			XXh
2C87h			XXh
2C88h	DTC Control Data 9	DTCD9	XXh
2C89h			XXh
2C8Ah			XXh
2C8Bh			XXh
2C8Ch			XXh
2C8Dh			XXh
2C8Eh			XXh
2C8Fh			XXh
2C90h	DTC Control Data 10	DTCD10	XXh
2C91h			XXh
2C92h			XXh
2C93h			XXh
2C94h			XXh
2C95h			XXh
2C96h			XXh
2C97h			XXh
2C98h	DTC Control Data 11	DTCD11	XXh
2C99h			XXh
2C9Ah			XXh
2C9Bh			XXh
2C9Ch			XXh
2C9Dh			XXh
2C9Eh			XXh
2C9Fh			XXh
2CA0h	DTC Control Data 12	DTCD12	XXh
2CA1h			XXh
2CA2h			XXh
2CA3h			XXh
2CA4h			XXh
2CA5h			XXh
2CA6h			XXh
2CA7h			XXh
2CA8h	DTC Control Data 13	DTCD13	XXh
2CA9h			XXh
2CAAh			XXh
2CABh			XXh
2CACh			XXh
2CADh			XXh
2CAEh			XXh
2CAFh			XXh

X: Undefined
Note:
1. The blank areas are reserved and cannot be accessed by users.

Table 4.16 SFR Information (16) (1)

Address	Register	Symbol	After reset
2EF0h	CAN0 Mailbox15 : Message ID	C0MB15	XXh
2EF1h			XXh
2EF2h			XXh
2EF3h			XXh
2EF4h			
2EF5h	CAN0 Mailbox15 : Data length		XXh
2EF6h	CAN0 Mailbox15 : Data field		XXh
2EF7h			XXh
2EF8h			XXh
2EF9h			XXh
2EFAh			XXh
2EFBh			XXh
2EFCh			XXh
2EFDh			XXh
2EFEh	CAN0 Mailbox15 : Time stamp		XXh
2EFFh			XXh
2F00h			
2F01h			
2F02h			
2F03h			
2F04h			
2F05h			
2F06h			
2F07h			
2F08h			
2F09h			
2F0Ah			
2F0Bh			
2F0Ch			
2F0Dh			
2F0Eh			
2F0Fh			
2F10h	CAN0 Mask Register 0	C0MKR0	XXh
2F11h			XXh
2F12h			XXh
2F13h			XXh
2F14h	CAN0 Mask Register 1	C0MKR1	XXh
2F15h			XXh
2F16h			XXh
2F17h			XXh
2F18h	CAN0 Mask Register 2	C0MKR2	XXh
2F19h			XXh
2F1Ah			XXh
2F1Bh			XXh
2F1Ch	CAN0 Mask Register 3	C0MKR3	XXh
2F1Dh			XXh
2F1Eh			XXh
2F1Fh			XXh
2F20h	CAN0 FIFO Received ID Compare Register 0	C0FIDCR0	XXh
2F21h			XXh
2F22h			XXh
2F23h			XXh
2F24h	CAN0 FIFO Received ID Compare Register 1	C0FIDCR1	XXh
2F25h			XXh
2F26h			XXh
2F27h			XXh
2F28h			
2F29h			
2F2Ah	CAN0 Mask Invalid Register	C0MKIVLR	XXh
2F2Bh			XXh
2F2Ch			
2F2Dh			
2F2Eh	CAN0 Mailbox Interrupt Enable Register	C0MIER	XXh
2F2Fh			XXh
2F30h	CAN0 Message Control Register 0	C0MCTL0	00h
2F31h	CAN0 Message Control Register 1	C0MCTL1	00h
2F32h	CAN0 Message Control Register 2	C0MCTL2	00h
2F33h	CAN0 Message Control Register 3	C0MCTL3	00h
2F34h	CAN0 Message Control Register 4	C0MCTL4	00h
2F35h	CAN0 Message Control Register 5	C0MCTL5	00h
2F36h	CAN0 Message Control Register 6	C0MCTL6	00h
2F37h	CAN0 Message Control Register 7	C0MCTL7	00h
2F38h	CAN0 Message Control Register 8	C0MCTL8	00h
2F39h	CAN0 Message Control Register 9	C0MCTL9	00h
2F3Ah	CAN0 Message Control Register 10	C0MCTL10	00h

X: Undefined

Note:

1. The blank areas are reserved and cannot be accessed by users.

Table 4.17 SFR Information (17) (1)

Address	Register	Symbol	After reset
2F3Bh	CAN0 Message Control Register 11	C0MCTL11	00h
2F3Ch	CAN0 Message Control Register 12	C0MCTL12	00h
2F3Dh	CAN0 Message Control Register 13	C0MCTL13	00h
2F3Eh	CAN0 Message Control Register 14	C0MCTL14	00h
2F3Fh	CAN0 Message Control Register 15	C0MCTL15	00h
2F40h	CAN0 Control Register	C0CTLR	00000101b
2F41h			00h
2F42h	CAN0 Status Register	C0STR	00000101b
2F43h			00h
2F44h	CAN0 Bit Configuration Register	C0BCR	00h
2F45h			00h
2F46h			00h
2F47h			
2F48h	CAN0 Receive FIFO Control Register	C0RFCR	10000000b
2F49h	CAN0 Receive FIFO Pointer Control Register	C0RFPCR	XXh
2F4Ah	CAN0 Transmit FIFO Control Register	C0TFCR	10000000b
2F4Bh	CAN0 Transmit FIFO Pointer Control Register	C0TFPCR	XXh
2F4Ch	CAN0 Error Interrupt Enable Register	C0EIER	00h
2F4Dh	CAN0 Error Interrupt Factor Judge Register	C0EIFR	00h
2F4Eh	CAN0 Reception Error Count Register	C0RECR	00h
2F4Fh	CAN0 Transmission Error Count Register	C0TECR	00h
2F50h	CAN0 Error Code Store Register	C0ECSR	00h
2F51h	CAN0 Channel Search Support Register	C0CSSR	XXh
2F52h	CAN0 Mailbox Search Status Register	C0MSSR	10000000b
2F53h	CAN0 Mailbox Search Mode Register	C0MSMR	00h
2F54h	CAN0 Time Stamp Register	C0TSR	00h
2F55h			00h
2F56h	CAN0 Acceptance Filter Support Register	C0AFSR	XXh
2F57h			XXh
2F58h	CAN0 Test Control Register	C0TCR	00h
:			
2FFFh			

X: Undefined

Note:

1. The blank areas are reserved and cannot be accessed by users.

Table 4.18 ID Code Areas and Option Function Select Area

Address	Area Name	Symbol	After Reset
:			
FFDBh	Option Function Select Register 2	OFS2	(Note 1)
:			
FFDFh	ID1		(Note 2)
:			
FFE3h	ID2		(Note 2)
:			
FFEBh	ID3		(Note 2)
:			
FFEFh	ID4		(Note 2)
:			
FFF3h	ID5		(Note 2)
:			
FFF7h	ID6		(Note 2)
:			
FFFBh	ID7		(Note 2)
:			
FFFFh	Option Function Select Register	OFS	(Note 1)

Notes:

1. The option function select area is allocated in the flash memory, not in the SFRs. Set appropriate values as ROM data by a program.
   Do not write additions to the option function select area. If the block including the option function select area is erased, the option function select area is set to FFh.
   When blank products are shipped, the option function select area is set to FFh. It is set to the written value after written by the user.
   When factory-programming products are shipped, the value of the option function select area is the value programmed by the user.
2. The ID code areas are allocated in the flash memory, not in the SFRs. Set appropriate values as ROM data by a program.
   Do not write additions to the ID code areas. If the block including the ID code areas is erased, the ID code areas are set to FFh.
   When blank products are shipped, the ID code areas are set to FFh. They are set to the written value after written by the user.
   When factory-programming products are shipped, the value of the ID code areas is the value programmed by the user.

Table 5.4 A/D Converter Characteristics

Symbol	Parameter		Conditions		Standard			Unit
					Min.	Typ.	Max.	
–	Resolution		V_{ref} = AV_{CC}		–	–	10	Bit
–	Absolute accuracy	10-bit mode	V_{ref} = AV_{CC} = 5.0 V	AN0 to AN7 input, AN8 to AN11 input	–	–	±3	LSB
			V_{ref} = AV_{CC} = 3.0 V	AN0 to AN7 input, AN8 to AN11 input	–	–	±5	LSB
		8-bit mode	V_{ref} = AV_{CC} = 5.0 V	AN0 to AN7 input, AN8 to AN11 input	–	–	±2	LSB
			V_{ref} = AV_{CC} = 3.0 V	AN0 to AN7 input, AN8 to AN11 input	–	–	±2	LSB
ϕAD	A/D conversion clock		4.0 ≤ V_{ref} = AV_{CC} = ≤ 5.5 (2)		2	–	20	MHz
			2.7 ≤ V_{ref} = AV_{CC} = ≤ 5.5 (2)		2	–	10	MHz
–	Tolerance level impedance				–	3	–	kΩ
I_{vref}	V_{ref} current		V_{CC} = 5.0 V, XIN = f1 = ϕAD = 20 MHz		–	45	–	µA
t_{CONV}	Conversion time	10-bit mode	V_{ref} = AV_{CC} = 5.0 V, ϕAD = 20 MHz		2.2	–	–	µs
		8-bit mode	V_{ref} = AV_{CC} = 5.0 V, ϕAD = 20 MHz		2.2	–	–	µs
t_{SAMP}	Sampling time		ϕAD = 20 MHz		0.8	–	–	µs
V_{ref}	Reference voltage				2.7	–	AV_{CC}	V
V_{IA}	Analog input voltage (3)				0	–	V_{ref}	V
OCVREF	On-chip reference voltage		2 MHz ≤ ϕAD ≤ 4 MHz		1.14	1.34	1.54	V

Notes:
1. V_{CC}/AV_{CC} = V_{ref} = 2.7 to 5.5 V, V_{SS} = 0 V at T_{opr} = –40 to 85°C (J version) / –40 to 125°C (K version), unless otherwise specified.
2. The A/D conversion result will be undefined in wait mode, stop mode, when the flash memory stops, and in low-consumption current mode. Do not perform A/D conversion in these states or transition to these states during A/D conversion.
3. When the analog input voltage is over the reference voltage, the A/D conversion result will be 3FFh in 10-bit mode and FFh in 8-bit mode.

Table 5.6 Flash Memory (Data flash Block A to Block D) Electrical Characteristics

Symbol	Parameter	Conditions	Standard			Unit
			Min.	Typ.	Max.	
–	Program/erase endurance (2)		10,000 (3)	–	–	times
–	Byte program time (program/erase endurance ≤ 1,000 times)		–	160	950	µs
–	Byte program time (program/erase endurance > 1,000 times)		–	300	950	µs
–	Block erase time (program/erase endurance ≤ 1,000 times)		–	0.2	1	s
–	Block erase time (program/erase endurance > 1,000 times)		–	0.3	1	s
$t_{d(SR-SUS)}$	Time delay from suspend request until suspend		–	–	3+CPU clock × 3 cycles	ms
–	Interval from erase start/restart until following suspend request		0	–	–	µs
–	Time from suspend until erase restart		–	–	30+CPU clock × 1 cycle	µs
$t_{d(CMDRST-READY)}$	Time from when command is forcibly terminated until reading is enabled		–	–	30+CPU clock × 1 cycle	µs
–	Program, erase voltage		2.7	–	5.5	V
–	Read voltage		2.7	–	5.5	V
–	Program, erase temperature		–40	–	85 (J version) 125 (K version)	°C
–	Data hold time (7)	Ambient temperature = 55 °C (8)	20	–	–	year

Notes:
1. V_{CC} = 2.7 to 5.5 V at T_{opr} = –40 to 85°C (J version) / –40 to 125°C (K version), unless otherwise specified.
2. Definition of programming/erasure endurance
   The programming and erasure endurance is defined on a per-block basis.
   If the programming and erasure endurance is n (n = 100, 1,000, 10,000), each block can be erased n times. For example, if 1,024 1-byte writes are performed to different addresses in block A, a 1 Kbyte block, and then the block is erased, the programming/erasure endurance still stands at one.
   However, the same address must not be programmed more than once per erase operation (overwriting prohibited).
3. Endurance to guarantee all electrical characteristics after program and erase. (1 to Min. value can be guaranteed).
4. In a system that executes multiple programming operations, the actual erasure count can be reduced by writing to sequential addresses in turn so that as much of the block as possible is used up before performing an erase operation. For example, when programming groups of 16 bytes, the effective number of rewrites can be minimized by programming up to 128 groups before erasing them all in one operation. In addition, averaging the erasure endurance between blocks A to D can further reduce the actual erasure endurance. It is also advisable to retain data on the erasure endurance of each block and limit the number of erase operations to a certain number.
5. If an error occurs during block erase, attempt to execute the clear status register command, then execute the block erase command at least three times until the erase error does not occur.
6. Customers desiring program/erase failure rate information should contact their Renesas technical support representative.
7. The data hold time includes time that the power supply is off or the clock is not supplied.
8. This data hold time includes 3,000 hours in Ta = 125°C and 7,000 hours in Ta = 85°C.

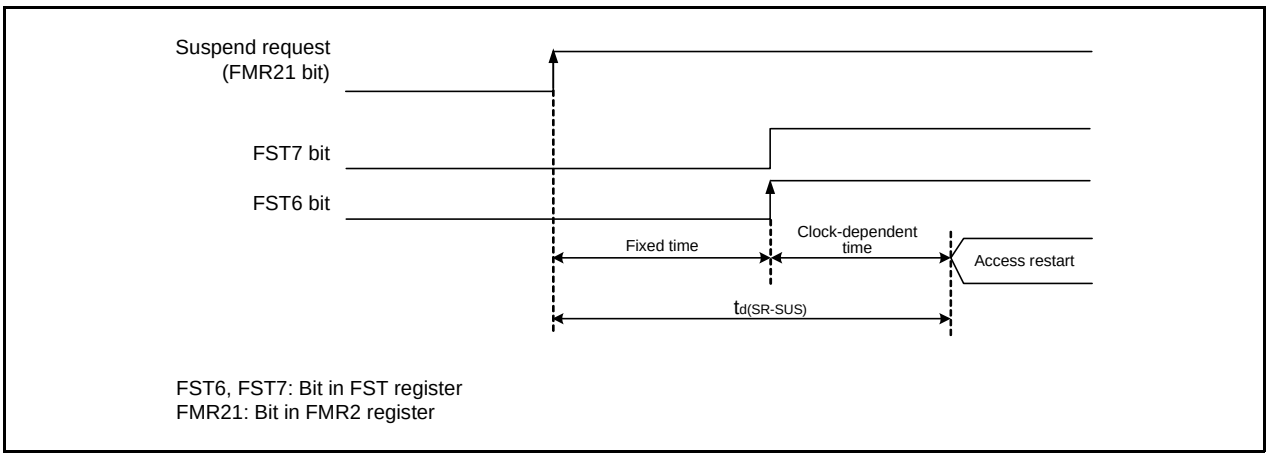
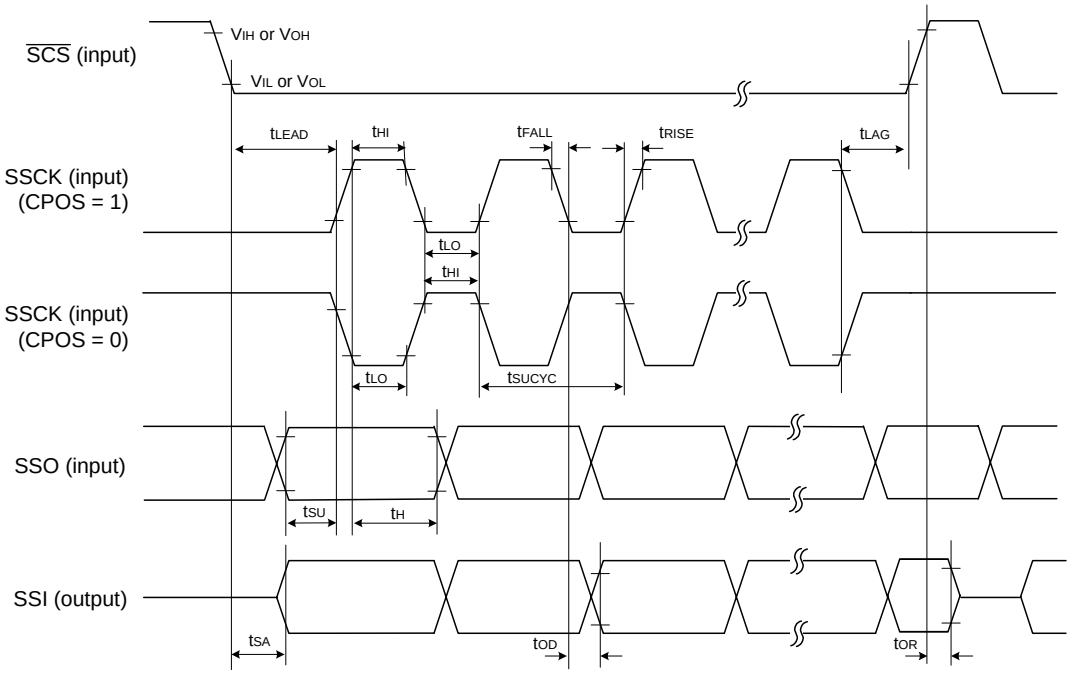
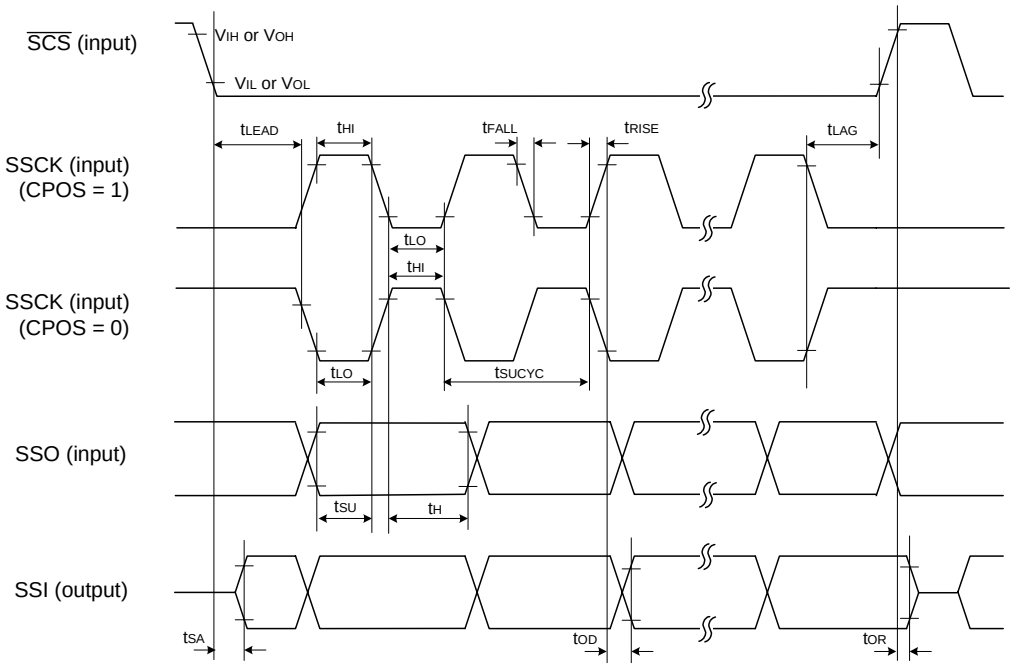


Figure 5.2 Time delay until Suspend

4-Wire Bus Communication Mode, Slave, CPHS = 1



4-Wire Bus Communication Mode, Slave, CPHS = 0



CPHS, CPOS: Bits in SSMR register

Figure 5.5 I/O Timing of SSU (Slave)

Table 5.24 Electrical Characteristics (4) [2.7 V ≤ Vcc < 3.3 V] (Topr = –40 to 125°C (K version), unless otherwise specified.)

Symbol	Parameter	Condition		Standard			Unit
				Min.	Typ.	Max.	
Icc	Power supply current (Vcc = 2.7 to 3.3 V) Single-chip mode, output pins are open, other pins are Vss	High-speed clock mode (1)	XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	–	7.0	14.5	mA
			XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	–	5.6	12.0	mA
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	–	3.6	–	mA
			XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	–	3.0	–	mA
			XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	–	2.2	–	mA
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	–	1.5	–	mA
		High-speed on-chip oscillator mode (1)	XIN clock off High-speed on-chip oscillator on fOCO-F = 20 MHz Low-speed on-chip oscillator on = 125 kHz No division	–	7.0	14.5	mA
			XIN clock off High-speed on-chip oscillator on fOCO-F = 20 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8	–	3.0	–	mA
		Low-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8, FMR27 = 1, VCA20 = 0	–	85	390	µA
		Wait mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	–	15	320	µA
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	–	5	310	µA
		Stop mode	XIN clock off, Topr = 25°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0	–	2.0	5.0	µA
			XIN clock off, Topr = 125°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0	–	55.0	–	µA

Note:
1. The typical value (Typ.) indicates the current value when the CPU and the memory operate.
The maximum value (Max.) indicates the current when the CPU, the memory, and the peripheral functions operate and the flash memory is programmed/erased.

Timing requirements
(Unless Otherwise Specified: Vcc = 3 V, Vss = 0 V at Topr = –40°C to 85°C (J ver)/–40°C to 125°C (K ver))

Table 5.25 External clock input (XOUT)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(XOUT)}$	XOUT input cycle time	50	–	ns
$t_{WH(XOUT)}$	XOUT input “H” width	24	–	ns
$t_{WL(XOUT)}$	XOUT input “L” width	24	–	ns

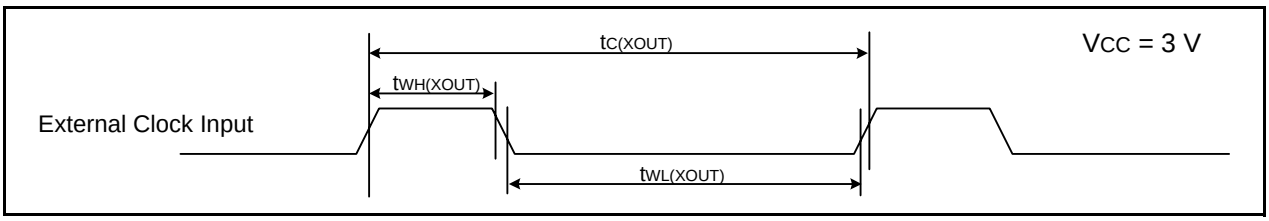


Figure 5.11 External Clock Input Timing Diagram when Vcc = 3 V

Table 5.26 TRAIO Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TRAIO)}$	TRAIO input cycle time	300	–	ns
$t_{WH(TRAIO)}$	TRAIO input “H” width	120	–	ns
$t_{WL(TRAIO)}$	TRAIO input “L” width	120	–	ns

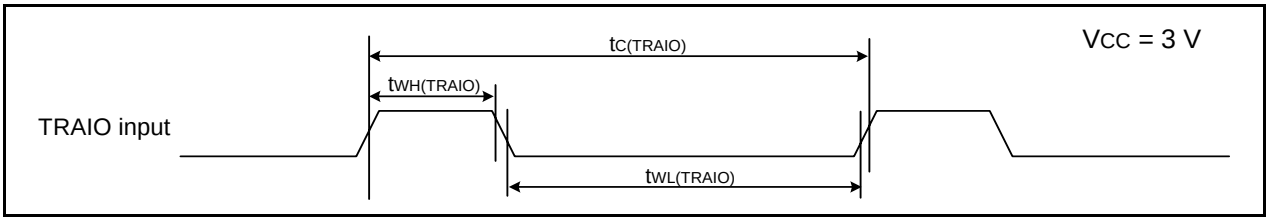


Figure 5.12 TRAIO Input Timing Diagram when Vcc = 3 V

Table 5.27 Serial Interface

Symbol	Parameter	Condition	Standard		Unit
			Min.	Max.	
$t_{c(CK)}$	CLKi input cycle time	When external clock selected	300	–	ns
$t_{W(CKH)}$	CLKi input “H” width		150	–	ns
$t_{W(CKL)}$	CLKi Input “L” width		150	–	ns
$t_{d(C-Q)}$	TXDi output delay time		–	120	ns
$t_{h(C-Q)}$	TXDi hold time		0	–	ns
$t_{su(D-C)}$	RXDi input setup time		30	–	ns
$t_{h(C-D)}$	RXDi input hold time		90	–	ns
$t_{d(C-Q)}$	TXDi output delay time	When internal clock selected	–	30	ns
$t_{su(D-C)}$	RXDi input setup time		120	–	ns
$t_{h(C-D)}$	RXDi input hold time		90	–	ns

i = 0, 2

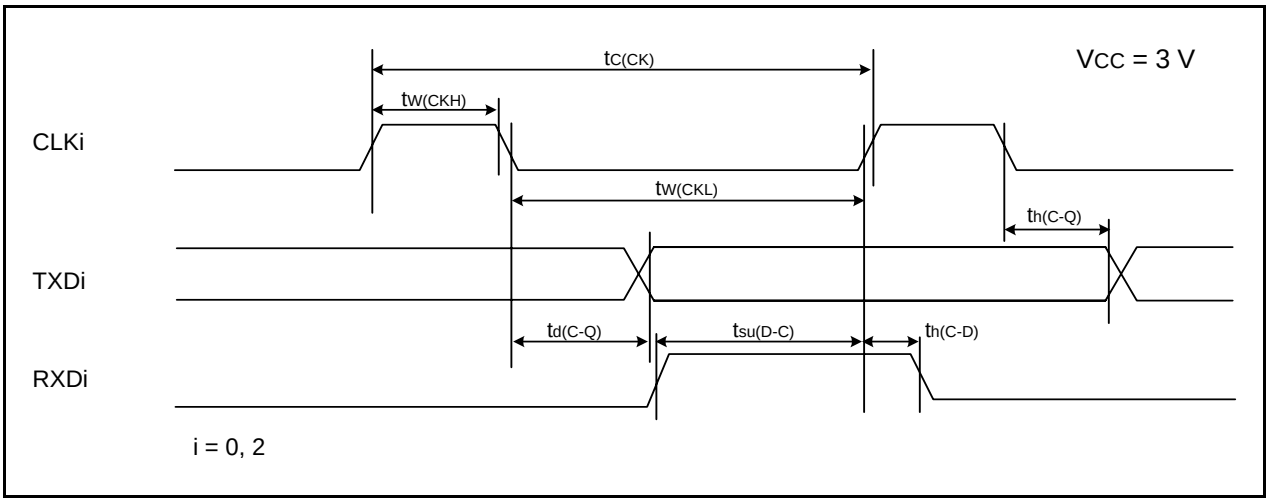


Figure 5.13 Serial Interface Timing Diagram when Vcc = 3 V

Table 5.28 External Interrupt $\overline{\text{INTi}}$ (i = 0 to 4) Input, Key Input Interrupt $\overline{\text{KIi}}$ (i = 0 to 3)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{W(INH)}$	$\overline{\text{INTi}}$ input “H” width, $\overline{\text{KIi}}$ input “H” width	380 (1)	–	ns
$t_{W(INL)}$	$\overline{\text{INTi}}$ input “L” width, $\overline{\text{KIi}}$ input “L” width	380 (2)	–	ns

Notes:
1. When selecting the digital filter by the $\overline{\text{INTi}}$ input filter select bit, use an $\overline{\text{INTi}}$ input HIGH width of either (1/digital filter clock frequency × 3) or the minimum value of standard, whichever is greater.
2. When selecting the digital filter by the $\overline{\text{INTi}}$ input filter select bit, use an $\overline{\text{INTi}}$ input LOW width of either (1/digital filter clock frequency × 3) or the minimum value of standard, whichever is greater.

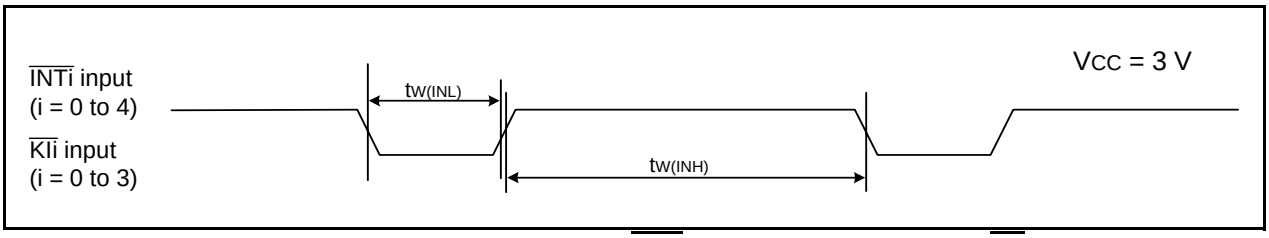


Figure 5.14 Input Timing for External Interrupt $\overline{\text{INTi}}$ and Key Input Interrupt $\overline{\text{KIi}}$ when Vcc = 3 V